# Advance Information 

## 28-Bit Configurable Registered Buffer for DDR2

## Recommended Application:

- DDR2 Memory Modules
- Provides complete DDR DIMM solution with ICS97U877
- Ideal for DDR2 400, 533 and 667


## Product Features:

- 28-bit 1:2 registered buffer with parity check functionality
- Supports SSTL_18 JEDEC specification on data inputs and outputs
- Supports LVCMOS switching levels on CSGEN and RESET\# inputs
- Low voltage operation
$\mathrm{V}_{\mathrm{DD}}=1.7 \mathrm{~V}$ to 1.9 V
- Available in 176 BGA package
- Green packages available

| Pin Configuration ${ }_{2}$ |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  |  |  |  |
| A | $\bigcirc$ | 0 |  | 0 | - | - | 0 | 0 | 0 | $\bigcirc$ |
| в | 0 | 0 | 0 | 0 | 0 | $\bigcirc$ | 0 |  | 0 | 0 |
| c | 0 | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | 0 |
| - | 0 | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | 0 |
| E | 0 | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | 0 |
| $F$ | - | 0 | 0 | 0 | 0 | - | 0 |  | 0 | 0 |
| G | 0 | 0 | 0 | 0 | 0 | - | 0 |  | 0 | 0 |
| н | O | 0 | 0 | 0 | 0 | - | 0 |  | 0 | 0 |
| J | 0 | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | 0 |
| к | 0 | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | 0 |
| $\llcorner$ | 0 | 0 | 0 | 0 | 0 | - | 0 |  | 0 | 0 |
| м | O | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | 0 |
| N | O | 0 | - | 0 | - | 0 | 0 |  | 0 | 0 |
| P | 0 | 0 | 0 | 0 | 0 | 0 | 0 |  | 0 | 0 |
| R | 0 | 0 | - | 0 | 0 | 0 | 0 |  | 0 | 0 |
| T | 0 | 0 | - | 0 | 0 | 0 | 0 |  | 0 | 0 |
| $\checkmark$ | O | 0 | - | 0 | 0 | 0 | 0 |  | 0 | 0 |
| $\checkmark$ | 0 | 0 |  | 0 | 0 | 0 | 0 |  | 0 | 0 |
| w | - | - | - | 0 | - | - | 0 |  | 0 | $\bigcirc$ |
| r | O | 0 |  | 0 | 0 | - | 0 |  | 0 | 0 |
| A | 0 | 0 | - | 0 | 0 | 0 | 0 |  | - | 0 |
| Ав | $\bigcirc$ | 0 |  |  | 0 | $\bigcirc$ | 0 |  | 0 | 0 |

176 Ball BGA
(Top View)

Functionality Truth Table

| Inputs |  |  |  |  |  |  | Outputs |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RST\# | DCSO\# | DCS1\# | CSGEN | CK | CK\# | Dn, DODTn, DCKEn | Qn | QCS0\# | QCS1\# | QODT, QCKE |
| H | L | L | X | $\uparrow$ | $\downarrow$ | L | L | L | L | L |
| H | L | L | X | $\uparrow$ | $\downarrow$ | H | H | L | L | H |
| H | L | L | X | L or H | L or H | X | $\mathrm{Q}_{0}$ | $\mathrm{Q}_{0}$ | $\mathrm{Q}_{0}$ | $\mathrm{Q}_{0}$ |
| H | L | H | X | $\uparrow$ | $\downarrow$ | L | L | L | H | L |
| H | L | H | x | $\uparrow$ | $\downarrow$ | H | H | L | H | H |
| H | L | H | X | L or H | L or H | X | $\mathrm{Q}_{0}$ | $Q_{0}$ | $Q_{0}$ | $\mathrm{Q}_{0}$ |
| H | H | L | X | $\uparrow$ | $\downarrow$ | L | L | H | L | L |
| H | H | L | X | $\uparrow$ | $\downarrow$ | H | H | H | L | H |
| H | H | L | X | L or H | L or H | X | $\mathrm{Q}_{0}$ | $Q_{0}$ | $Q_{0}$ | $\mathrm{Q}_{0}$ |
| H | H | H | L | $\uparrow$ | $\downarrow$ | L | L | H | H | L |
| H | H | H | L | $\uparrow$ | $\downarrow$ | H | H | H | H | H |
| H | H | H | L | L or H | L or H | X | $\mathrm{Q}_{0}$ | $Q_{0}$ | $Q_{0}$ | $Q_{0}$ |
| H | H | H | H | $\uparrow$ | $\downarrow$ | L | $\mathrm{Q}_{0}$ | H | H | L |
| H | H | H | H | $\uparrow$ | $\downarrow$ | H | $\mathrm{Q}_{0}$ | H | H | H |
| H | H | H | H | L or H | L or H | X | $\mathrm{Q}_{0}$ | $Q_{0}$ | $Q_{0}$ | $Q_{0}$ |
| L | $\begin{gathered} X \text { or } \\ \text { floating } \end{gathered}$ | $\begin{gathered} \text { X or } \\ \text { floating } \end{gathered}$ | $\begin{gathered} \mathrm{X} \text { or } \\ \text { floating } \end{gathered}$ | $\begin{gathered} \mathrm{X} \text { or } \\ \text { floating } \end{gathered}$ | $\mathrm{X} \text { or }$ floating | $\begin{gathered} \mathrm{X} \text { or } \\ \text { floating } \end{gathered}$ | L | L | L | L |

08/14/06

ICSSSTUB32S868D Advance Information

## Ball Assignments

| A | D2 | D1 | C | GND | $\mathrm{V}_{\text {REF }}$ | GND | Q1A | Q1B |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| B | D4 | D3 | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $V_{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q2A | Q2B |
| C | $\begin{gathered} \text { D6 } \\ \text { (DCKE1) } \end{gathered}$ | D5 | GND | GND | GND | GND | Q3A | Q3B |
| D | $\begin{gathered} \text { D8 } \\ \text { (DCKE0) } \end{gathered}$ | D7 | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q4A | Q4B |
| E | D9 | Q6A (QCKE1A) | GND | GND | GND | GND | Q5A | Q5B |
| F | D10 | Q8A QCKE0A | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q7A | Q6B (QCKE1B) |
| G | D11 | Q10A | GND | GND | GND | GND | Q9A | Q7B |
| H | D12 | Q12A | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q11A | $\begin{gathered} \text { Q8B } \\ \text { (QCKEOB) } \\ \hline \end{gathered}$ |
| J | DCS1\# | QCS1A\# | GND | GND | GND | GND | Q10B | Q9B |
| K | DCSO\# | QCSOA\# | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q12B | Q11B |
| L | CK | CSGEN | PAR_IN | GND | GND | GND | $\begin{gathered} \text { Q14B } \\ \text { (QCS0B\#) } \end{gathered}$ | $\begin{gathered} \text { Q13B } \\ \text { (QCS1B\#) } \end{gathered}$ |
| M | CK3 | RESET\# | QERR\# | $\mathrm{V}_{\mathrm{DD}}$ | $V_{D D}$ | $V_{D D}$ | $\begin{gathered} \text { Q15B } \\ \text { (QODTOB) } \end{gathered}$ | $\begin{gathered} \text { Q16B } \\ \text { (QODT1B) } \\ \hline \end{gathered}$ |
| N | $\begin{gathered} \hline \text { D15 } \\ \text { (DODT0) } \\ \hline \end{gathered}$ | $\begin{gathered} \text { Q15A } \\ \text { (QODTOA) } \\ \hline \end{gathered}$ | GND | GND | GND | GND | Q17B | Q18B |
| P | $\begin{gathered} \text { D16 } \\ \text { (DODT1) } \\ \hline \end{gathered}$ | $\begin{gathered} \text { Q16A } \\ \text { (QODT1A) } \end{gathered}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $V_{D D}$ | $V_{D D}$ | Q19B | Q20B |
| R | D17 | Q17A | GND | GND | GND | GND | Q18A | Q21B |
| T | D18 | Q19A | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q20A | Q23B |
| U | D19 | Q21A | GND | GND | GND | GND | Q22A | Q23B |
| V | D20 | Q23A | $V_{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q24A | Q24B |
| W | D21 | D22 | GND | GND | GND | GND | Q25A | Q25B |
| Y | D23 | D24 | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q26A | Q26B |
| AA | D25 | D26 | GND | GND | GND | GND | Q27A | Q27B |
| $A B$ | D27 | D28 | NC | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\text {REF }}$ | VDD | Q28A | Q28B |
| 1 2 3 4 5 6  |  |  |  |  |  |  |  |  |

Note: NC denotes a no-connect (ball present but not connected to the die).

ICSSSTUB32S868D
Advance Information

## Ball Assignments

| A | D2 | D1 | C | GND | $\mathrm{V}_{\text {REF }}$ | GND | Q1A | Q1B |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| B | D4 | D3 | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q2A | Q2B |
| C | D6 | D5 | GND | GND | GND | GND | Q3A | Q3B |
| D | D8 | D7 | $V_{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $V_{\text {DD }}$ | Q4A | Q4B |
| E | D9 | Q6A | GND | GND | GND | GND | Q5A | Q5B |
| F | D10 | Q8A | $V_{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $V_{\text {DD }}$ | Q7A | Q6B |
| G | D11 | Q10A | GND | GND | GND | GND | Q9A | Q7B |
| H | D12 | Q12A | $V_{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q11A | Q8B |
| J | $\begin{gathered} \text { D13 } \\ \text { (DODT1) } \\ \hline \end{gathered}$ | $\begin{gathered} \text { Q13A } \\ \text { (QODT1A) } \end{gathered}$ | GND | GND | GND | GND | Q10B | Q9B |
| K | $\begin{gathered} \text { D14 } \\ \text { (DODT0) } \\ \hline \end{gathered}$ | $\begin{gathered} \text { Q14A } \\ \text { (QODTOA) } \\ \hline \end{gathered}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q12B | Q11B |
| L | CK | CSGEN | PAR_IN | GND | GND | GND | $\begin{gathered} \text { Q14B } \\ \text { (QODTOB) } \end{gathered}$ | $\begin{gathered} \text { Q13B } \\ \text { (QODT1B) } \end{gathered}$ |
| M | CK\# | RESET\# | QERR\# | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\begin{gathered} \text { Q15B } \\ \text { (QCS0B\#) } \\ \hline \end{gathered}$ | $\begin{gathered} \text { Q16B } \\ \text { (QCS1B\#) } \\ \hline \end{gathered}$ |
| N | $\begin{gathered} \text { D15 } \\ \text { (DCSO\#) } \end{gathered}$ | $\begin{gathered} \text { Q15A } \\ \text { (QCSO\#) } \end{gathered}$ | GND | GND | GND | GND | Q17B | Q18B |
| P | $\begin{gathered} \text { D16 } \\ \text { (DCS1\#) } \end{gathered}$ | $\begin{gathered} \text { Q16A } \\ \text { (QCS1A\#) } \end{gathered}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q19B | Q20B |
| R | D17 | Q17A | GND | GND | GND | GND | Q18A | $\begin{gathered} \text { Q21B } \\ \text { (QCKEOB) } \end{gathered}$ |
| T | D18 | Q19 | $V_{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $V_{\text {DD }}$ | Q20A | Q22B |
| U | D19 | $\begin{gathered} \text { Q21A } \\ \text { (QCKEOA) } \\ \hline \end{gathered}$ | GND | GND | GND | GND | Q22A | $\begin{gathered} \text { Q23B } \\ \text { (QCKE1B) } \end{gathered}$ |
| V | D20 | $\begin{gathered} \text { Q23A } \\ \text { (QCKE1A) } \\ \hline \end{gathered}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q24A | Q24B |
| W | $\begin{gathered} \text { D21 } \\ \text { (DCKE0) } \\ \hline \end{gathered}$ | D22 | GND | GND | GND | GND | Q25A | Q25B |
| Y | $\begin{gathered} \text { D23 } \\ \text { (DCKE1) } \\ \hline \end{gathered}$ | D24 | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Q26A | Q26B |
| AA | D25 | D26 | GND | GND | GND | GND | Q27A | Q27B |
| $A B$ | D27 | D28 | NC | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\text {REF }}$ | VDD | Q28A | Q28B |
|  | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |
| 1:2 Register $\mathrm{B}(\mathrm{C}=1)$ |  |  |  |  |  |  |  |  |

Note: NC denotes a no-connect (ball present but not connected to the die).

ICSSSTUB32S868D Advance Information

## General Description

This 28-bit 1:2 configurable registered buffer is designed for $1.7-\mathrm{V}$ to $1.9-\mathrm{V}$ VDD operation. All inputs are compatible with the JEDEC standard for SSTL_18, except the chip-select gate-enable (CSGEN), control (C), and reset (RESET) inputs, which are LVCMOS. All outputs are edge-controlled circuits optimized for unterminated DIMM loads, and meet SSTL_18 specifications, except the open-drain error (QERR) output.

The ICSSSTUB32S868D operates from a differential clock (CK and CK). Data are registered at the crossing of CK going high and CK going low. The device supports low-power standby operation. When RESET is low, the differential input receivers are disabled, and undriven (floating) data, clock, and reference voltage (VREF) inputs are allowed. In addition, when RESET is low, all registers are reset and all outputs are forced low except QERR. The LVCMOS RESET and C inputs always must be held at a valid logic high or low level. To ensure defined outputs from the register before a stable clock has been supplied, RESET must be held in the low state during power up. In the DDR2 RDIMM application, RESET is specified to be completely asynchronous with respect to CK and CK. Therefore, no timing relationship can be ensured between the two. When entering reset, the register will be cleared and the data outputs will be driven low quickly, relative to the time to disable the differential input receivers. However, when coming out of reset, the register will become active quickly, relative to the time to enable the differential input receivers. As long as the data inputs are low, and the clock is stable during the time from the low-to-high transition of RESET until the input receivers are fully enabled, the design of the ICSSSTUB32S868D must ensure that the outputs will remain low, thus ensuring no glitches on the output.

| Inputs |  |  |  |  |  |  | Output |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RST\# | DCS0\# | DCS1\# | CK | CK\# | $\begin{gathered} \Sigma \text { of inputs }=\mathrm{H} \\ (\mathrm{D} 1-\mathrm{D} 28) \end{gathered}$ | PAR_IN ${ }^{\dagger}$ | QERR\# ${ }^{\ddagger}$ |
| H | L | X | $\uparrow$ | $\downarrow$ | Even | L | H |
| H | L | X | $\uparrow$ | $\downarrow$ | Odd | L | L |
| H | L | X | $\uparrow$ | $\downarrow$ | Even | H | L |
| H | L | X | $\uparrow$ | $\downarrow$ | Odd | H | H |
| H | X | L | $\uparrow$ | $\downarrow$ | Even | L | H |
| H | X | L | $\uparrow$ | $\downarrow$ | Odd | L | L |
| H | X | L | $\uparrow$ | $\downarrow$ | Even | H | L |
| H | X | L | $\uparrow$ | $\downarrow$ | Odd | H | H |
| H | H | H | $\uparrow$ | $\downarrow$ | X | X | QERR\#\# ${ }^{\text {§ }}$ |
| H | X | X | L or H | L or H | X | X | QERR $\#_{0}$ |
| L | $\begin{gathered} \mathrm{X} \text { or } \\ \text { floating } \end{gathered}$ | $\begin{gathered} \mathrm{X} \text { or } \\ \text { floating } \end{gathered}$ | $\begin{gathered} \mathrm{X} \text { or } \\ \text { floating } \end{gathered}$ | $\begin{gathered} \mathrm{X} \text { or } \\ \text { floating } \end{gathered}$ | X | X or floating | H |

$\dagger$ PAR_IN arrives one clock cycle after the data to which it applies.
$\ddagger$ This transition assumes QERR\# is high at the crossing of CK going high and CK\#
going low. If QERR\# is low, it stays latches low for two clock cycles or until RST\# is driven low.
§ If DCSO\#, DCS1\#, and CSGEN are driven high, the device is placed in low-power mode (LPM). If a parity error occurs on the clock cycle before the device enters the LPM and the QERR\# output is driven low, it stays latches low for the LPM duration plus two clock cycles or until RST\# is driven low.

ICSSSTUB32S868D Advance Information

## General Description (Continued)

The ICSSSTUB32S868D includes a parity checking function. Parity, which arrives one cycle after the data input to which it applies, is checked on the PAR_IN input of the device. The corresponding QERR output signal for the data inputs is generated two clock cycles after the data, to which the QERR signal applies, is registered. The ICSSSTUB32S868D accepts a parity bit from the memory controller on the parity bit (PAR_IN) input, compares it with the data received on the DIMM-independent D-inputs (D1-D5, D7, D9-D12, D17-D28 when $\bar{C}=0$; or D1-D12, D17-D20, D22, D24-D28 when $C=1$ ) and indicates whether a parity error has occurred on the open-drain QERR pin (active low). The convention is even parity, i.e., valid parity is defined as an even number of ones across the DIMM-independent data inputs combined with the parity input bit. To calculate parity, all DIMM-independent D-inputs must be tied to a known logic state. If an error occurs and the QERR output is driven low, it stays latched low for a minimum of two clock cycles or until RESET is driven low. If two or more consecutive parity errors occur, the QERR output is driven low and latched low for a clock duration equal to the parity error duration or until RESET is driven low. If a parity error occurs on the clock cycle before the device enters the low-power (LPM) and the QERR output is driven low, then it stays lateched low for the LPM duration plus two clock cycles or until RESET is driven low. The DIMM-dependent signals (DCKE0, DCKE1, DODT0, DODT1, DCS0 and DCS1) are not included in the parity check computation.

The C input controls the pinout configuration from register-A configuration (when low) to register-B configuration (when high). The C input should not be switched during normal operation. It should be hardwired to a valid low or high level to configure the register in the desired mode. The device also supports low-power active operation by monitoring both system chip select (DCS0 and DCS1) and CSGEN inputs and will gate the Qn outputs from changing states when CSGEN, DCS0, and DCS1 inputs are high. If CSGEN, DCS0 or DCS1 input is low, the Qn outputs will function normally. Also, if both DCS0 and DCS1 inputs are high, the device will gate the QERR output from changing states. If either DCS0 or DCS1 is low, the QERR output will function normally. The RESET input has priority over the DCS0 and DCS1 control and when driven low will force the Qn outputs low, and the QERR output high. If the chip-select control functionality is not desired, then the CSGEN input can be hard-wired to ground, in which case, the setup-time requirement for DCS0 and DCS1 would be the same as for the other D data inputs. To control the low-power mode with DCS0 and DCS1 only, then the CSGEN input should be pulled up to VDD through a pullup resistor. The two VREF pins (A1 and V1) are connected together internally by approximately 150 .. However, it is necessary to connect only one of the two VREF pins to the external VREF power supply. An unused VREF pin should be terminated with a VREF coupling capacitor.

ICSSSTUB32S868D Advance Information

## Ball Assignment

| Terminal name | Description | Electrical characteristics |
| :---: | :---: | :---: |
| GND | Ground | Grourd input |
| $\mathrm{V}_{\mathrm{DD}}$ | Power supply voltage | 1.8-V nominal |
| $\mathrm{V}_{\text {REF }}$ | Input reference voltage | 0.9-V nominal |
| CK | Positive master clock input | Differential input |
| CK\# | Negative master clock input | Differential input |
| C | Configuration control inputs - Register A or Register B | LVCMOS inputs |
| RST\# | Asynchronous reset input - resets registers and disables VREF data and clock differential-input receivers | LVCMOS input |
| CSGEN | Chip select gate enable - When high, D1-D28 $\dagger$ inputs will be latched only when at least one chip select input is low during the rising edge of the clock. When low, theD1-D28† inputs will be latched and redriven on every rising edge of the clock. | LVCMOS input |
| D1-D28† | Data input - clocked in on the crossing of the rising edge of CK and the falling edge of CK\#. | SSTL_18 input |
| $\begin{gathered} \text { DCSO\#, } \\ \text { DCS1\# } \end{gathered}$ | Chip select inputs - These pins initiate DRAM address/command decodes, and as such at least one will be low when a valid address/command is present. The Register can be programmed to redrive all D inputs (CSGEN high) only when atleast one chip select input is low. If CSGEN, DCS0\#, and DCS1\# inputs are high, D1-D28† inputs will be disabled. | SSTL_18 input |
| DODTO, DODT1 | The outputs of this register bit will not be suspended by the DCO\# and DCS1\# control. | SSTL_18 input |
| DCKEO, <br> DCKE1 | The outputs of this register bit will not be suspended by the DC0\# and DCS1\# control. | SSTL_18 input |
| PAR_IN | Parity input - arrives one clock cycle after the corresponding data input. | SSTL_18 input |
| Q1-Q28 $\ddagger$ | Data outputs that are suspended by the DC0\# and DCS1\# control. | 1.8-V CMOS outputs |
| QCS0\#, QCS1\# | Data output that will not be suspended by the DC0\# and DCS1\# control. | 1.8-V CMOS output |
| QODTO, QODT1 | Data output that will not be suspended by the DC0\# and DCS1\# control. | 1.8-V CMOS output |
| QCKEO, QCKE1 | Data output that will not be suspended by the DC0\# and DCS1\# control. | 1.8-V CMOS output |
| QERR\# | Output error bit - generated one clock cycle after the corresponding data output | Open-drain output |
| NC | No internal connection |  |
| $\dagger$ Data inputs = D1-D5, D7, D9-D12, D17-D28 when C=0 |  |  |
| Data inputs = D1-D12, D17-D20, D22, D24-D28 when C=1 |  |  |
| $\ddagger$ Data outputs = Q1-Q5, Q7, Q9-Q12, Q17-Q28 when C=0 |  |  |
| Data outputs = Q1-Q12, Q17-Q20, Q22, Q24-Q28 when C=1 |  |  |

[^0]ICSSSTUB32S868D Advance Information

## Block Diagram



Register A configuration with $\mathrm{C}=\mathrm{O}$; (positive logic)

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## Parity Logic Diagram



Register A configuration with $\mathrm{C}=\mathrm{O}$; (positive logic)

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## Block Diagram



Register $B$ configuration with $C=1$; (positive logic)

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## Parity Logic Diagram



Register $B$ configuration with $C=1$; (positive logic)

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## RegisterTiming


$\dagger$ After RESET\# is switched from low to high, all data and PAR_IN input signals must be set and held low for a minimum time of tact max, to avoid false error
$\ddagger$ If the data is clocked in on the n clock pulse, the QERR\# output sognal will be produced on the $\mathrm{n}+2$ clock pulse and it will be valid on the $\mathrm{n}+3$ clock pulse.

ICSSSTUB32S868D Advance Information

## RegisterTiming



Output signal is dependent on the prior unknown input event


H or L
$\dagger$ If the data is clocked in on the $n$ clock pulse, the QERR\# output signal will be generated on the $n+2$ clock pulse and it will be valid on the $\mathrm{n}+3$ clock pulse. If an error occurs and the QERR\# output is driven low, it stays low for a minimum of two clock cycles or until RST\# is driven low.

ICSSSTUB32S868D Advance Information

## RegisterTiming



After RST\# is switched from high to low, all data and clock input signals must be held at valid logic levels (not floating) for a minimum time of $t_{\text {inact }}$ max.

ICSSSTUB32S868D Advance Information

## Absolute Maximum Ratings

| Stor | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| :---: | :---: |
| Supply Voltage | -0.5 to 2.5V |
| Input Voltage ${ }^{1}$ | -0.5 to VDD + 2.5 V |
| Output Voltage ${ }^{1,2}$ | -0.5 to VDDQ + 0.5 |
| Input Clamp Current | $\pm 50 \mathrm{~mA}$ |
| Output Clamp Current | $\pm 50 \mathrm{~mA}$ |
| Continuous Output Current. | $\pm 50 \mathrm{~mA}$ |
| VDDQ or GND Current/Pin | $\pm 100 \mathrm{~mA}$ |
| Package Thermal Impedance ${ }^{3}$ | $36^{\circ} \mathrm{C}$ |

Notes:

1. The input and output negative voltage ratings may be excluded if the input and output clamp ratings are observed.
2. This current will flow only when the output is in the high state level $\mathrm{V}_{0}>\mathrm{V}_{\text {DDQ }}$.
3. The package thermal impedance is calculated in accordance with JESD 51.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Recommended Operating Conditions

${ }^{1}$ Guaranteed by design, not $100 \%$ tested in production.
Note: Reset\# and Cn inputs must be helf at valid logic levels (not floating) to ensure proper device operation. The differential inputs must not be floating unless Reset\# is low.

ICSSSTUB32S868D Advance Information

## Electrical Characteristics - DC

$\mathrm{T}_{\mathrm{A}}=0-70^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DD}}=2.5+/-0.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDQ}}=2.5+/-0.2 \mathrm{~V}$; (unless otherwise stated)

| SYMBOL | PARAMETERS | CONDITIONS |  | $\mathrm{V}_{\text {DDQ }}$ | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH voltage | $\mathrm{I}_{\mathrm{OH}}=-16 \mathrm{~mA}$ |  | 1.7 V | 1.2 | S |  | V |
| $\mathrm{V}_{\text {OL }}$ | Output LOW voltage |  |  | - |  | C | 0.2 |  |
|  |  | $\mathrm{I}_{\mathrm{OL}}=16 \mathrm{~mA}$ |  | 1.7 V |  |  | 0.5 |  |
| 1 | All Inputs | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{DD}}$ or GND |  | 1.9 V |  | N | $\pm 5$ | $\mu \mathrm{A}$ |
| $I_{\text {D }}$ | Standby (Static) | RESET\# = GND | $\mathrm{I}_{0}=0$ | 1.9 V |  |  | 200 | $\mu \mathrm{A}$ |
|  | Operating (Static) | $\begin{aligned} & \mathrm{V}_{1}=\mathrm{V}_{I H(A C)} \text { or } V_{i L(A C)}, \\ & R E S E T \#=V_{D D} \end{aligned}$ |  |  |  |  | 80 | mA |
| $I_{\text {DDD }}$ | Dynamic operating (clock only) | RESET\# = $V_{D D}$, $V_{I}=V_{\mathbb{H}(A C)}$ or $V_{I L(A C)}$, CLK and CLK\# switching $50 \%$ duty cycle. | $10=0$ | $1.8 \mathrm{~V}$ |  | 175 |  | $\mu /$ clock <br> MHz |
| $I_{\text {DDD }}$ | Dynamic Operating (per each data input) 1:2 mode | RESET\# = $V_{D D}$, $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{IH}(\mathrm{AC})}$ or $\mathrm{V}_{\mathrm{IL}}(\mathrm{AC})$, CLK and CLK\# switching $50 \%$ duty cycle. One data input switching at half clock frequency, 50\% duty cycle | $10=0$ | $1.8 \mathrm{~V}$ |  | $200$ |  | $\mu \mathrm{A} /$ clock MHz/data |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance, $D_{n}$, CSGEN, PAR_IN inputs | $V_{1}=V_{R E F} \pm 250 \mathrm{mV}$ | $\nabla^{2}$ | 1.8 V | 2.5 |  | 4 | pF |
|  | Input capacitance, $\text { DCS\# }{ }^{2}$ | $V_{1}=V_{\text {REF }} \pm 250 \mathrm{mV}$ | Single-die |  | 2.5 |  | 4 | pF |
|  | Input capacitance, CK and CK\# inputs ${ }^{2}$ | $\begin{aligned} & \mathrm{V}_{1 C R}=0.9 \mathrm{~V} ; \mathrm{V}_{\mathrm{IPP})}=600 \\ & \mathrm{mV} \end{aligned}$ | Single-die |  | 2 |  | 3 | pF |
|  | Input capacitance, RESET\# input | $V_{1}=V_{\text {DD }}$ or GND |  |  | Note 3 |  | Note 3 | pF |

Notes:
1 - Guaranteed by design, not $100 \%$ tested in production.
2 - The vendor must choose to comply with either single-die or dual-die specification in accordance to the device implementatic 3 - The vendor must supply this value for full device description.

## Output Buffer Characteristics

Output edge rates over recommended operating free-air temperature range (See figure 7)

| PARAMETER | $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V} \pm \mathbf{0 . 1 V}$ |  | UNIT |
| :---: | :---: | :---: | :---: |
|  | MIN | 4 |  |
| $\mathrm{dV} / \mathrm{dt} \_\mathrm{r}$ | 1 | 4 | ns |
| $\mathrm{dV} / \mathrm{dt} \_\mathrm{f}$ | 1 | 1 | ns |
| $\mathrm{dV} / \mathrm{dt} \_\Delta^{1}$ | - | ns |  |

1. Difference between dV/dt_r (rising edge rate) and dV/dt_f (falling edge rate)

ICSSSTUB32S868D Advance Information

## Timing Requirements

(over recommended operating free-air temperature range, unless otherwise noted)

| Symbol |  | Par | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency |  | - | 410 | MHz |
| $\mathrm{t}_{\mathrm{W}}$ | Pulse duration, CK, CK\# HIGH or LOW |  | 1 | - | ns |
| $\mathrm{t}_{\mathrm{ACT}}$ | Differential inputs active time (See Notes 1 and 2) |  | - | 10 | ns |
| $\mathrm{t}_{\text {INACT }}$ | Differential inputs inactive time (See Notes 1 and 3) |  | - | 15 | ns |
| ${ }^{\text {t }}$ U | Setup time | DCS before CK $\uparrow$, CK\# $\downarrow$, CSR\# before CK $\uparrow$, CK\# $\downarrow$ | 0.7 | - | ns |
|  | Setup time | DCS\# before CK $\uparrow$, CK\# $\downarrow$, | 0.5 |  | ns |
|  | Setup time | DODT, DCKE and data bef | 0.5 |  | ns |
|  | Setup time | PAR_IN before CK $\uparrow$, CK\# | 0.5 |  | ns |
| $\mathrm{t}_{\mathrm{H}}$ | Hold time | DCS\#, DODT, DCKE and | 0.6 | - | ns |
|  | Hold time | PAR_IN after CK $\uparrow$, CK\# $\downarrow$ | 0.5 | - | ns |

NOTE 1 This parameter is not necessarily production tested.
NOTE $2 \mathrm{~V}_{\text {REF }}$ must be held at a valid input voltage level and data inputs must be held low for a minimum time of $\mathrm{t}_{\mathrm{ACT}}$ (max) after RESET\# is taken high

NOTE $3 \quad \mathrm{~V}_{\text {REF }}$, Data and clock inputs must be held at valid voltage levels (not floating) a minimum time of t INACT (max) after RESET\# is taken low.

## Switching Characteristics

(over recommended operating free-air temperature range, unless otherwise noted)

| Symbol | Parameter | Measurement Conditions | MIN | MAX | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| fmax | Max input clock frequency |  | 410 |  | MHz |
| $\mathrm{t}_{\text {PDM }}$ | Propagation delay, single bit switching | CK $\uparrow$ to CK\#】 Qn | 1.2 | 1.9 | ns |
| $\mathrm{t}_{\mathrm{LH}}$ | Low to High propagation delay | CK $\uparrow$ to CK\#】 to QERR\# | 1.2 | 3 | ns |
| $\mathrm{t}_{\text {HL }}$ | High to low propagation delay | CK $\uparrow$ to $\mathrm{CK} \mathrm{\#} \downarrow$ to QERR\# | 1 | 2.4 | ns |
| tpDMss | Propagation delay simultaneous switching | CK $\uparrow$ to CK\# ${ }^{\text {an }}$ |  | 2 | ns |
| $\mathrm{t}_{\text {PHL }}$ | High to low propagation delay | Reset\# $\downarrow$ to Qn $\downarrow$ |  | 3 | ns |
| $\mathrm{t}_{\text {PLH }}$ | Low to High propagation delay | Reset\# $\downarrow$ to QERR\# $\uparrow$ |  | 3 | ns |

1. Guaranteed by design, not $100 \%$ tested in production.

ICSSSTUB32S868D Advance Information


Figure 6 - Parameter M easurement Infor mation ( $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V} \pm 0.1 \mathrm{~V}$ )

Notes: 1. $\mathrm{C}_{\mathrm{L}}$ incluces probe and jig capacitance.
2. $I_{D D}$ tested with clock and data inputs held at $\mathrm{V}_{\mathrm{DD}}$ or GND , and $\mathrm{Io}=0 \mathrm{~mA}$.
3. All input pulses are supplied by generators having the following chareacteristics: PRR $\unlhd 0 \mathrm{MHz}$, $\mathrm{Zo}=50 \Omega$, input slew rate $=1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$ (unless otherwise specified).
4. The outputs are measured one at a time with one transition per measurement.
5. $\mathrm{V}_{\text {REF }}=\mathrm{V}_{\mathrm{DD}} / 2$
6. $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{REF}}+250 \mathrm{mV}$ (ac voltage levels) for differential inputs. $\mathrm{V}_{I H}=\mathrm{V}_{\mathrm{DD}}$ for LVCMOS input.
7. $\mathrm{V}_{\mathrm{IL}}=\mathrm{V}_{\text {REF }}-250 \mathrm{mV}$ (ac voltage levels) for differential inputs. $\mathrm{V}_{\mathrm{IL}}=$ GND for LVCMOS input.
8. $\mathrm{V}_{\mathrm{ID}}=600 \mathrm{mV}$
9. $\mathrm{t}_{\text {PLH }}$ and $\mathrm{t}_{\mathrm{PHL}}$ are the same as $\mathrm{t}_{\text {PDM }}$.

ICSSSTUB32S868D Advance Information

Output slew rate measurement information ( $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V} \pm 0.1 \mathrm{~V}$ )
All input pulses are supplied by generators having the following characteristics: PRR 10 MHz ; $Z_{\mathrm{o}}=50 \quad$; input slew rate $=1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$, unless otherwise specified.

(1) $C_{L}$ includes probe and jig capacitance.

Figure 12 - Load circuit, HIGH-to-LOW slew measurement


Figure 13 - Voltage waveforms, HIGH-to-LOW slew rate measurement

(1) $C_{L}$ includes probe and jig capacitance.

Figure 14 - Load circuit, LOW-to-HIGH slew measurement


Figure 15 - Voltage waveforms, LOW-to-HIGH slew rate measurement

Error output load circuit and voltage measurement information ( $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V} \pm 0.1 \mathrm{~V}$ )
All input pulses are supplied by generators having the following characteristics: PRR 10 MHz ;
$Z_{o}=50$; input slew rate $=1 \mathrm{~V} / \mathrm{ns} \pm 20 \%$, unless otherwise specified.

(1) $C_{L}$ includes probe and jig capacitance.

Figure 16 - Load circuit, error output measurements


Figure 17 - Voltage waveforms, open-drain output LOW-to-HIGH transition time with respect to RST\# input


Figure 18 - Voltage waveforms, open-drain output HIGH-to-LOW transition time with respect to clock inputs


Figure 19 - Voltage waveforms, open-drain output LOW-to-HIGH transition time with respect to clock inputs

ICSSSTUB32S868D Advance Information


ALL DIMENSIONS IN MILLIMETERS

| D | E | T <br> Min/Max | e | ----- BALL GRID ----- |  |  | d <br> Min/Max | h <br> Min/Max | D1 | E1 | REF. DIMS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | HORIZ | VERT | TOTAL |  |  |  |  | b | C |
| 15.00 Bsc | 6.00 Bsc | 1.00/1.20 | 0.65 Bsc | 8 | 22 | 176 | 0.35/0.45 | 0.25/0.35 | 13.65 Bsc | 4.55 Bsc | 0.675 | 0.725 |

Note: Ball grid total indicates maximum ball count for package. Lesser quantity may be used.

* Source Ref.: JEDEC Publication 95, MO-205*, MO-225**, MO-246***

10-0055

## Ordering Information

## ICSSSTUB32S868DH(LF)-

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